OSRAM KW C3L5L2.TK

Datasheet

Published by ams-OSRAM AG
Tobelbader Strasse 30, 8141 Premstaetten, Austria
Phone +43 3136 500-0
ams-osram.com

OSRAM

OSLON® Submount PL

KW C3L5L2.TK

The OSLON Submount PL is able to meet a wide range of requirements in terms of output and adaptability to ambient conditions. It offers a uniform light pattern, thermal stability and great brightness.

Applications

- Dynamic Forward Lighting
- Static Forward Lighting

Features

- Package: compact lightsource in multi chip on board technology
- Chip technology: UX:3
- Typ. Radiation: 120° (Lambertian emitter)
- Color: Cx = 0.325, Cy = 0.345 acc. to CIE 1931 (● white)
- Corrosion Robustness Class: 3A
- Qualifications: AEC-Q102 Qualified
- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)
- Color over angle: Better than passus 3.7.2.1 of supplement proposal 7 to ECE reg. 128

AEC-Q102 QUALIFIED

Ordering Information

Type	Luminous Flux [1] I_F = 1000 mA Φ_V	Mounting methode	Ordering Code
KW C3L5L2.TK-T3T9-4L07M0	1100 ... 1425 lm	Top	Q65113A0769

Maximum Ratings

Parameter	Symbol		Values
Operating Temperature [2]	T_{op}	min. max.	-40 °C 135 °C
Storage Temperature	T_{stg}	min. max.	-40 °C 135 °C
Junction Temperature	T_j	max.	150 °C
Junction Temperature for short time applications*	T_j	max.	165 °C
Case Temperature	T_{case}	max.	135 °C
Forward current T_C = 25 °C	I_F	min. max.	50 mA 1500 mA
Surge current t ≤ 10 µs; D = 0.016 ; T_C = 25 °C	I_{FS}	max.	2500 mA
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	V_{ESD}		8 kV
Reverse current [3]	I_R	max.	200 mA

*The median lifetime (L70/B50) for Tj =165°C is 200h.
For Tc testing, please refer to Application Note: “AN085 Thermal measurement point of LEDs”

Characteristics

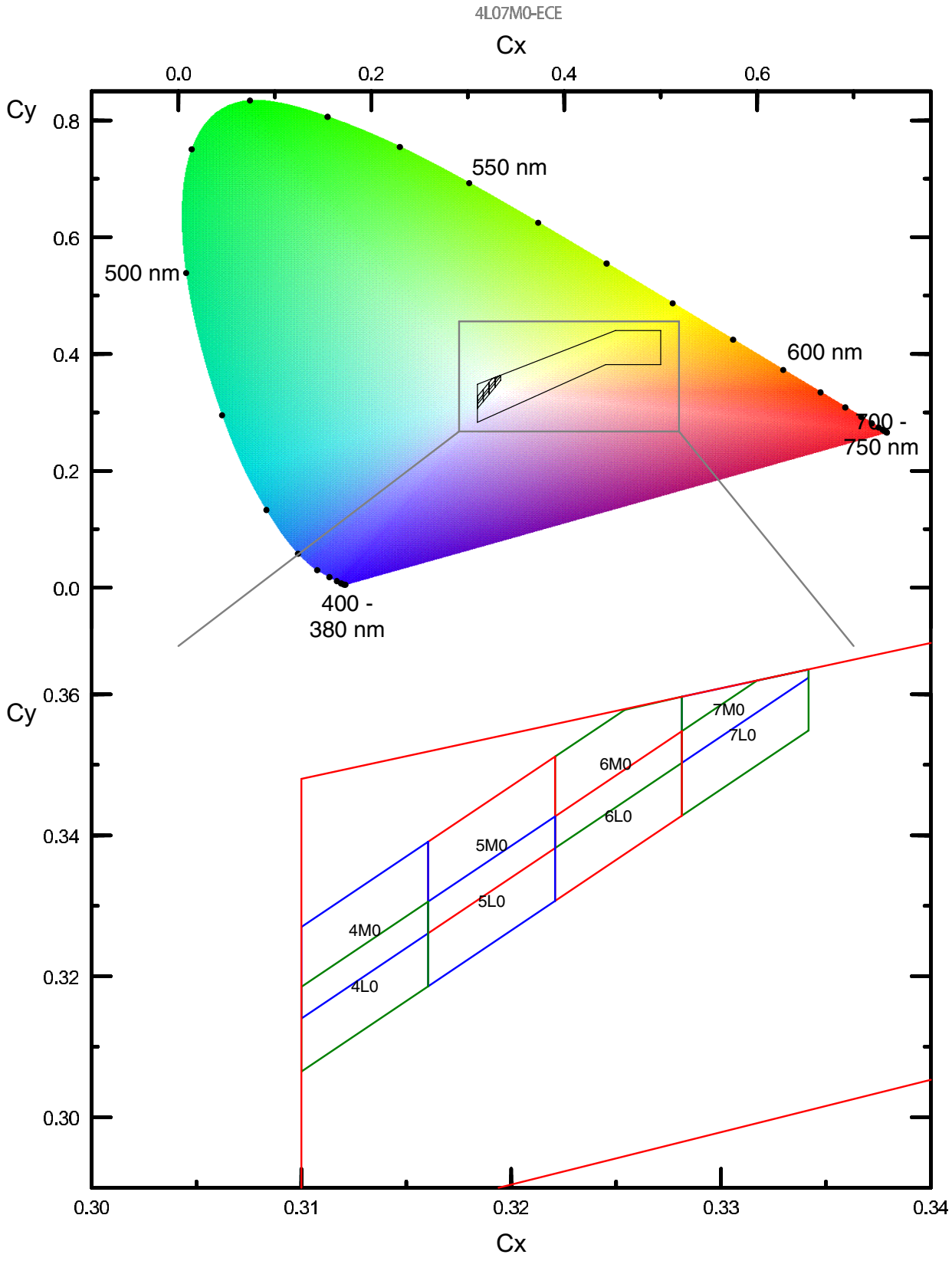
I_F = 1000 mA; T_C = 25 °C

Parameter	Symbol		Values
Chromaticity Coordinate [4]	Cx	typ.	0.325
	Cy	typ.	0.345
Viewing angle at 50% I_V	2φ	typ.	120 °
Radiating surface	A_{color}	typ.	3.3 mm²
Forward Voltage [5]	V_F	min.	8.40 V
I_F = 1000 mA		typ.	9.65 V
		max.	10.15 V
Reverse voltage (ESD device)	$V_{R\ ESD}$	min.	45 V
Reverse voltage [3]	V_R	max.	1.2 V
I_R = 20 mA			
Real thermal resistance junction/board [6]	$R_{thJB\ real}$	typ.	1.6 K / W
		max.	2.6 K / W
Electrical thermal resistance junction/board [6]	$R_{thJB\ elec.}$	typ.	0.99 K / W
with efficiency η_e = 38 %		max.	1.61 K / W

Brightness Groups

Group	Luminous Flux [1] I_F = 1000 mA min. Φ_V	Luminous Flux [1] I_F = 1000 mA max. Φ_V
T3	1100 lm	1140 lm
T4	1140 lm	1185 lm
T5	1185 lm	1230 lm
T6	1230 lm	1275 lm
T7	1275 lm	1325 lm
T8	1325 lm	1375 lm
T9	1375 lm	1425 lm

Chromaticity Coordinate Groups [4)]



Chromaticity Coordinate Groups [4)]

Group	Cx	Cy
4L0	0.3100	0.3065
	0.3100	0.3185
	0.3160	0.3306
	0.3160	0.3186
4M0	0.3100	0.3140
	0.3100	0.3270
	0.3160	0.3391
	0.3160	0.3261
5L0	0.3160	0.3186
	0.3160	0.3306
	0.3221	0.3427
	0.3221	0.3307

Group	Cx	Cy
5M0	0.3160	0.3261
	0.3160	0.3391
	0.3221	0.3512
	0.3221	0.3382
6L0	0.3221	0.3307
	0.3221	0.3427
	0.3281	0.3548
	0.3281	0.3428
6M0	0.3221	0.3382
	0.3221	0.3512
	0.3254	0.3578
	0.3281	0.3597
	0.3281	0.3503

Group	Cx	Cy
7L0	0.3281	0.3428
	0.3281	0.3548
	0.3317	0.3620
	0.3342	0.3635
	0.3342	0.3549
7M0	0.3281	0.3503
	0.3281	0.3597
	0.3342	0.3635
	0.3342	0.3624

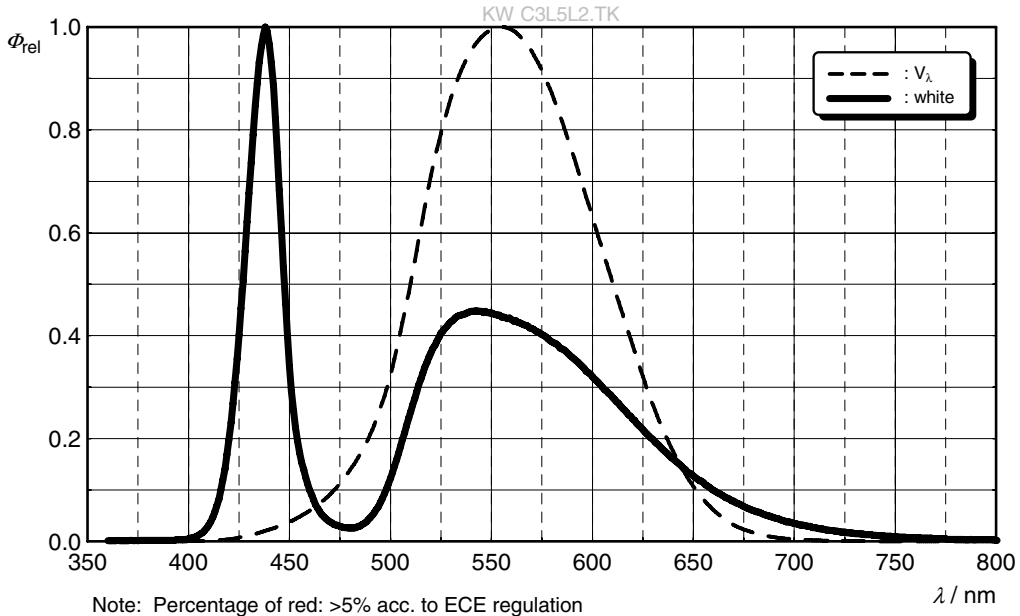
Group Name on Label

Example: T3-4L0

Brightness	Color Chromaticity
T3	4L0

Relative Spectral Emission [7)]

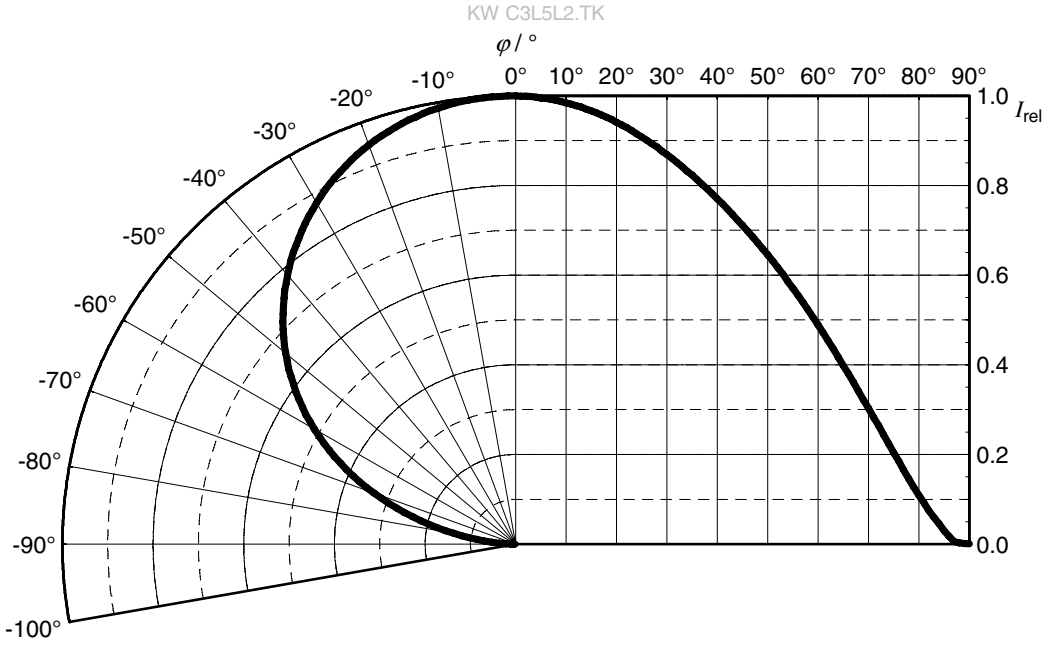
$\Phi_{rel} = f(\lambda)$; I_F = 1000 mA; T_C = 25 °C



Note: Percentage of red: >5% acc. to ECE regulation
Percentage of UV: <10^{-5}W/lm acc. to ECE regulation

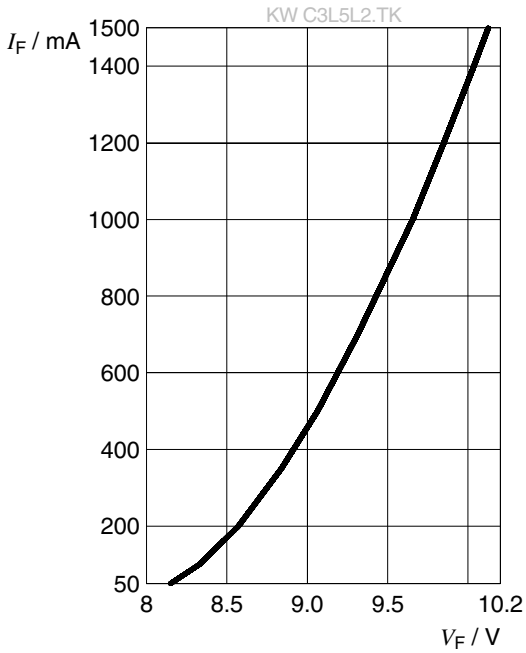
Radiation Characteristics [7)]

$I_{rel} = f(\phi)$; T_C = 25 °C



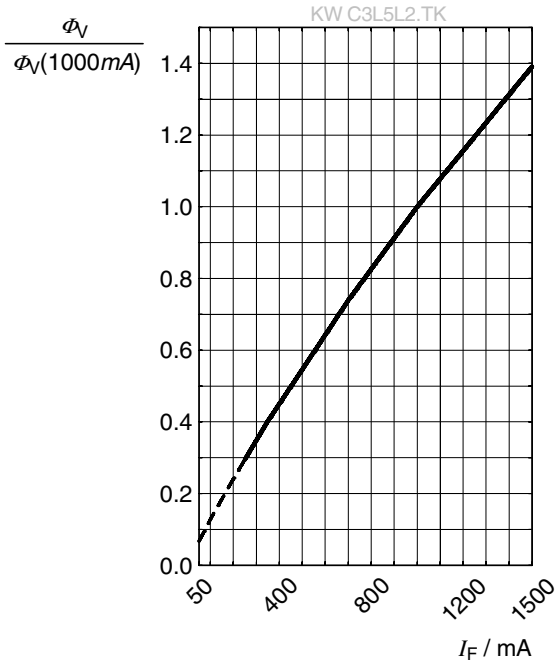
Forward current [7)]

$I_F = f(V_F)$; T_C = 25 °C



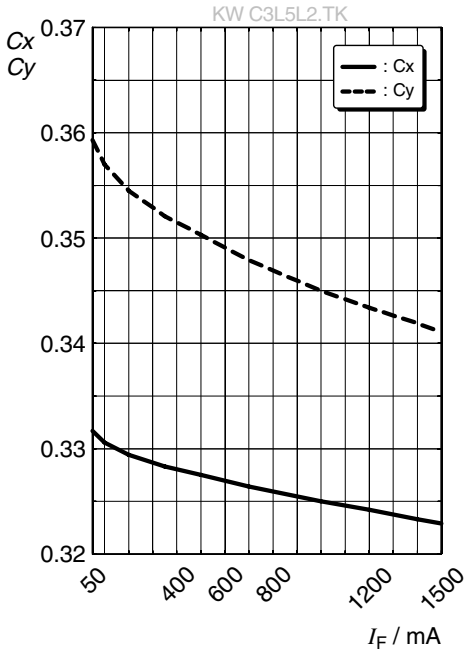
Relative Luminous Flux [7), 8)]

$\Phi_v/\Phi_v(1000\ mA) = f(I_F)$; T_C = 25 °C



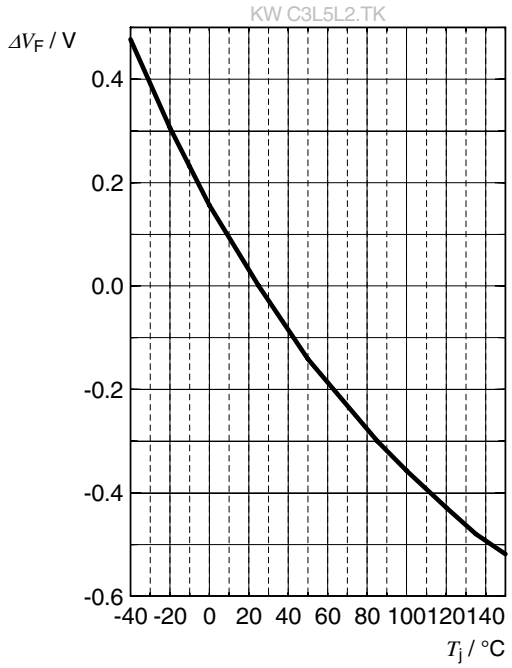
Chromaticity Coordinate Shift [7)]

Cx, Cy = $f(I_F)$; T_C = 25 °C



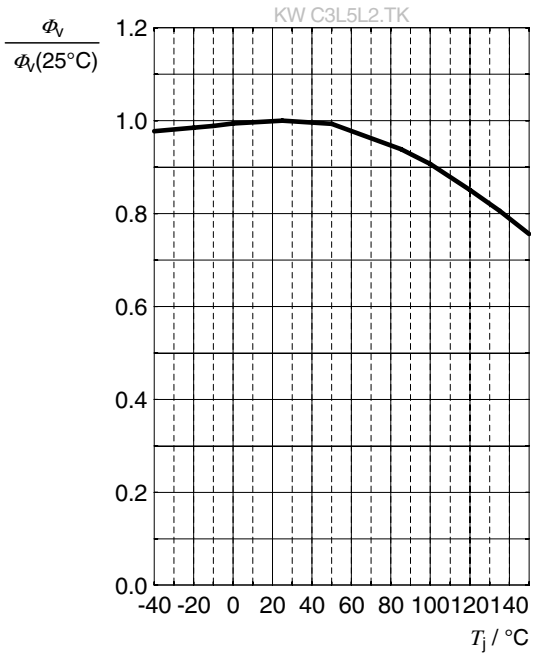
Forward Voltage [7)]

$\Delta V_F = V_F - V_F(25\ °C) = f(T_j);\ I_F = 1000\ mA$



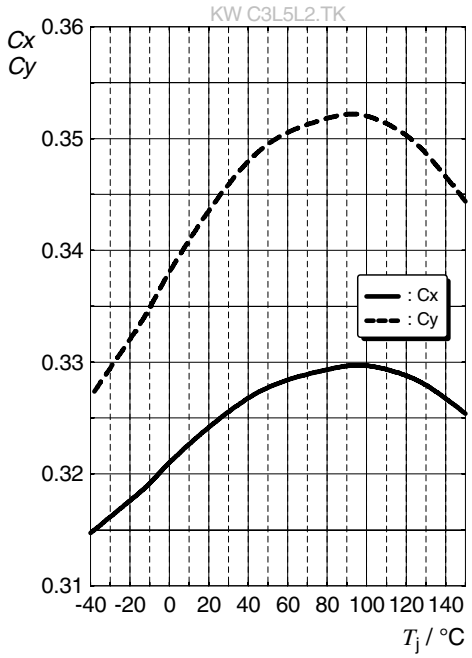
Relative Luminous Flux [7)]

$\Phi_v/\Phi_v(25\ °C) = f(T_j);\ I_F = 1000\ mA$



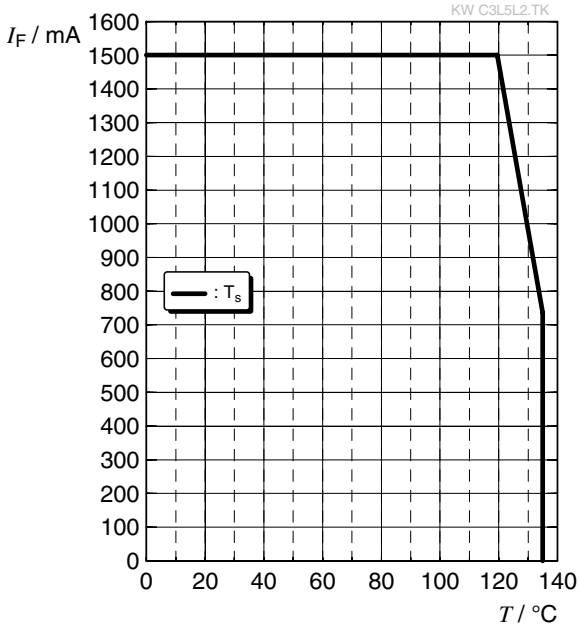
Chromaticity Coordinate Shift [7)]

$Cx, Cy = f(T_j);\ I_F = 1000\ mA$



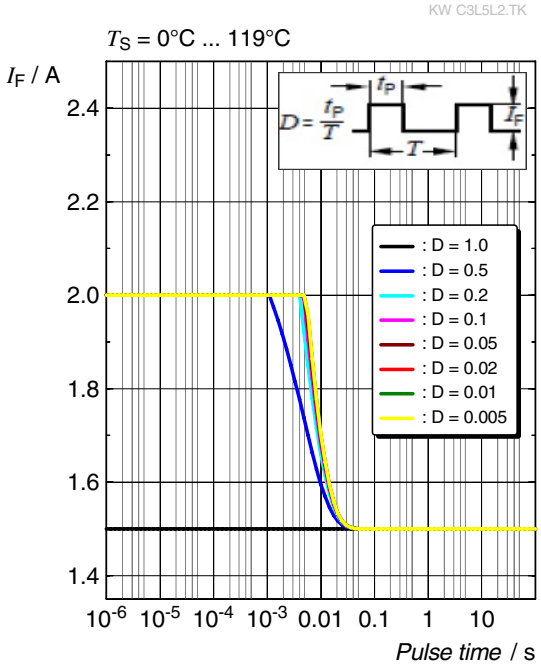
Max. Permissible Forward Current [6)]

$I_F = f(T)$



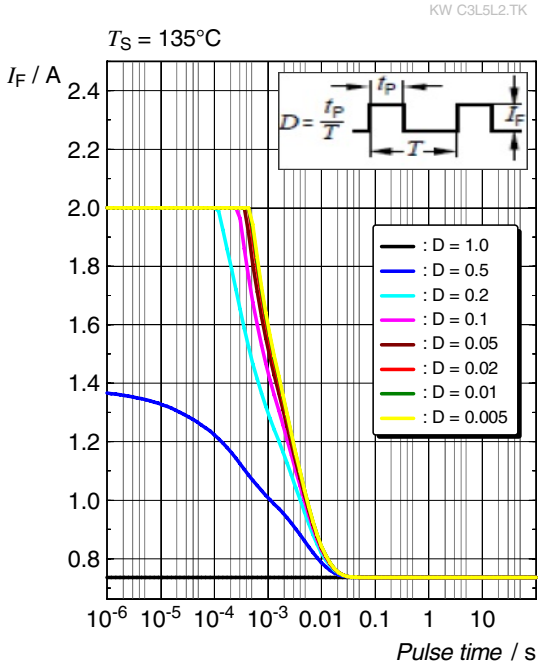
Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle



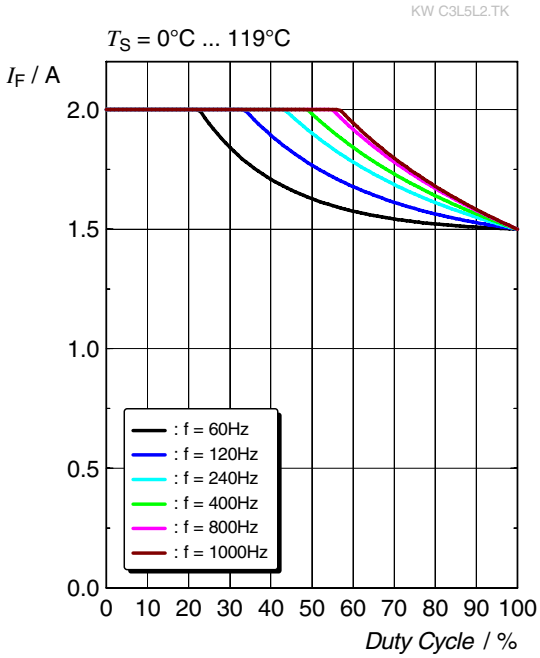
Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle



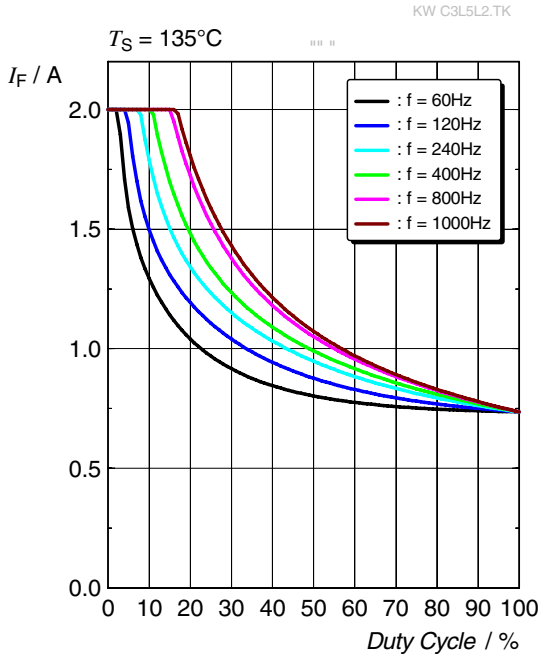
Permissible F. Handling Capability

f: Frequency

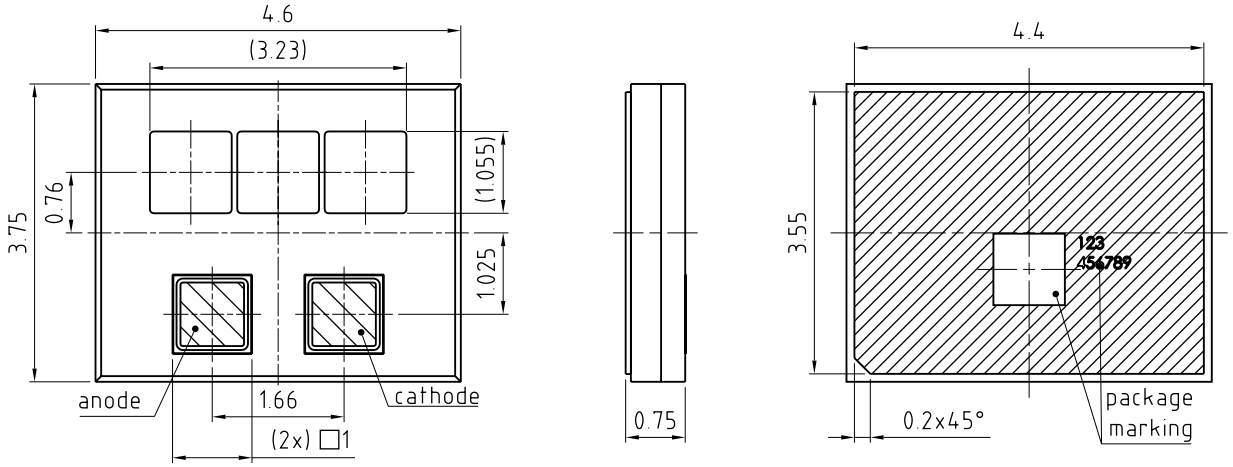


Permissible F. Handling Capability

f: Frequency



Dimensional Drawing [9)]



general tolerance ± 0.1

lead finish Au

lead finish Al

C67062-A0353-A1-02

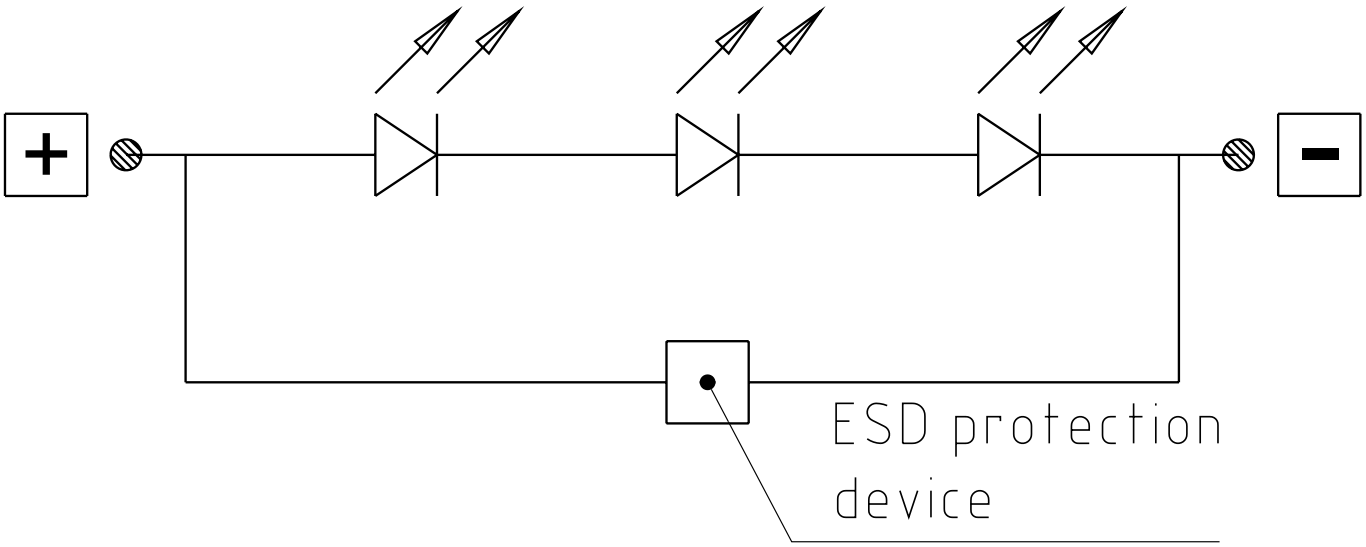
Further Information:

Approximate Weight: 38.0 mg

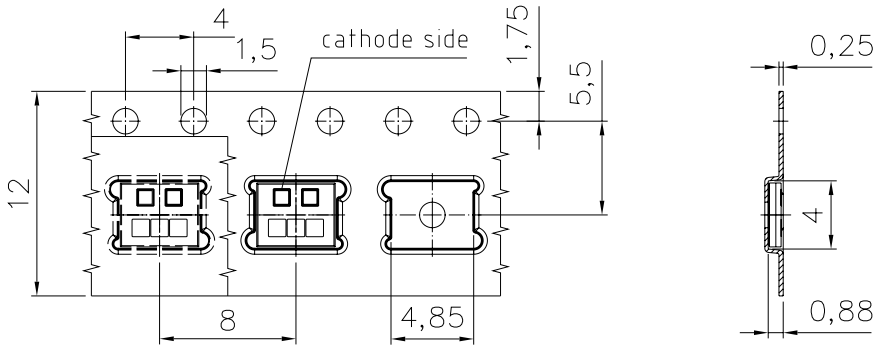
Corrosion test: Class: 3A
Test condition: 40°C / 90 % RH / 15 ppm H_2S / 14 days (stricter than IEC 60068-2-43)

ESD advice: The device is protected by ESD device which is connected in parallel to the Chip.

Electrical Internal Circuit

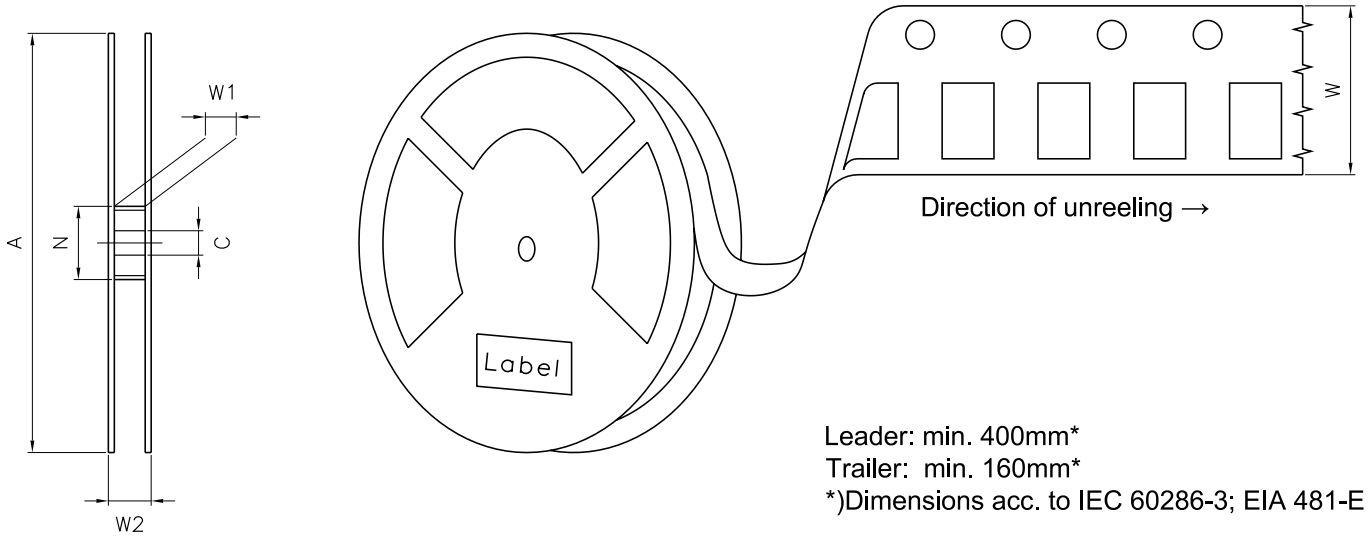


Taping [9)]



C67062-A0353-B9-01

Tape and Reel [10)]

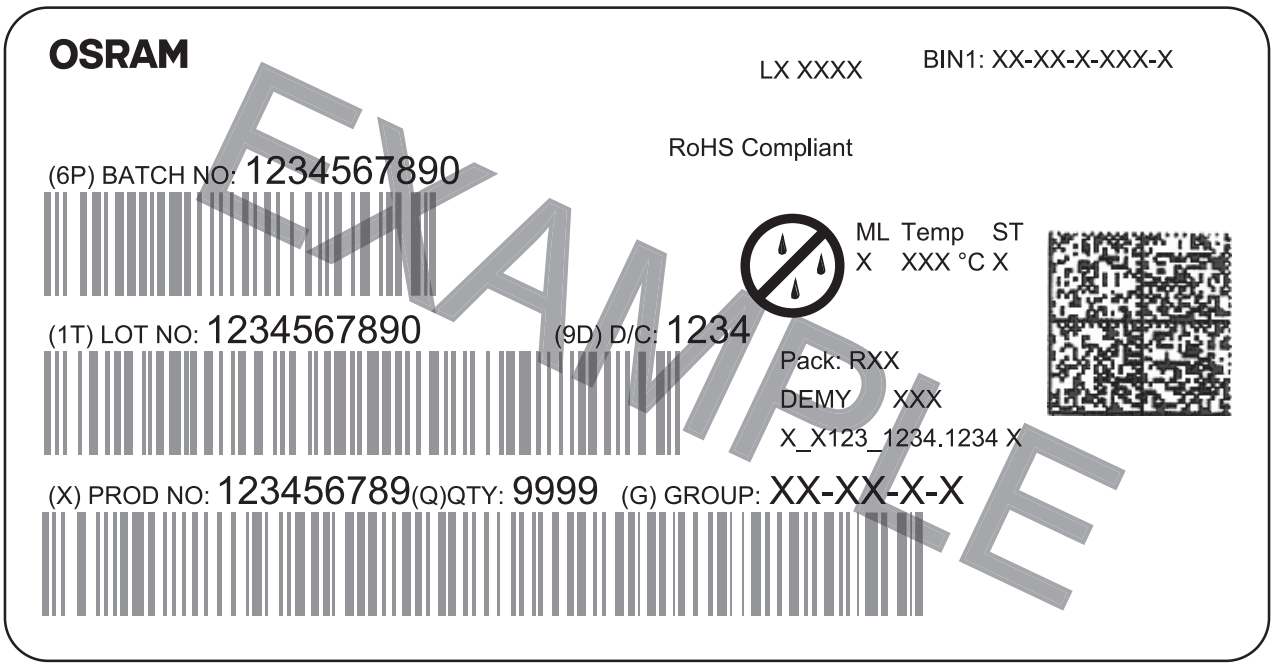


Leader: min. 400mm*
Trailer: min. 160mm*
*)Dimensions acc. to IEC 60286-3; EIA 481-E

Reel Dimensions

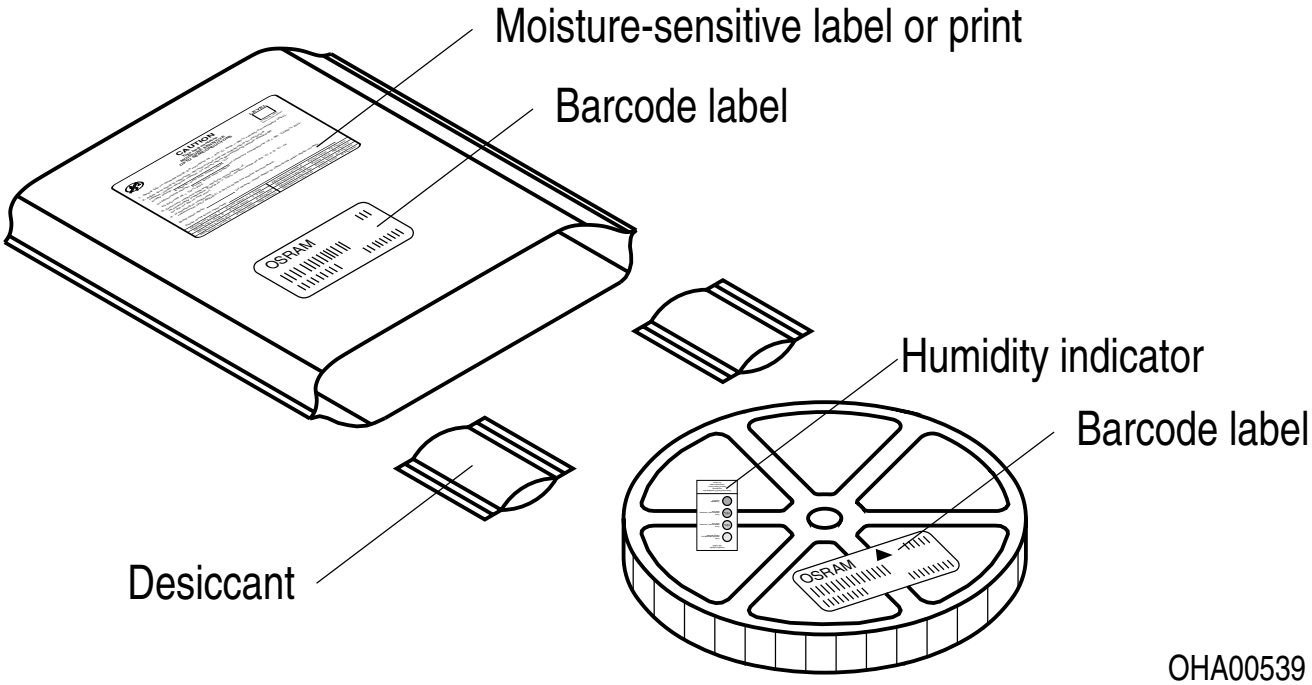
A	W	N_{min}	W_1	$W_{2\,max}$	Pieces per PU
180 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	2000

Barcode-Product-Label (BPL)



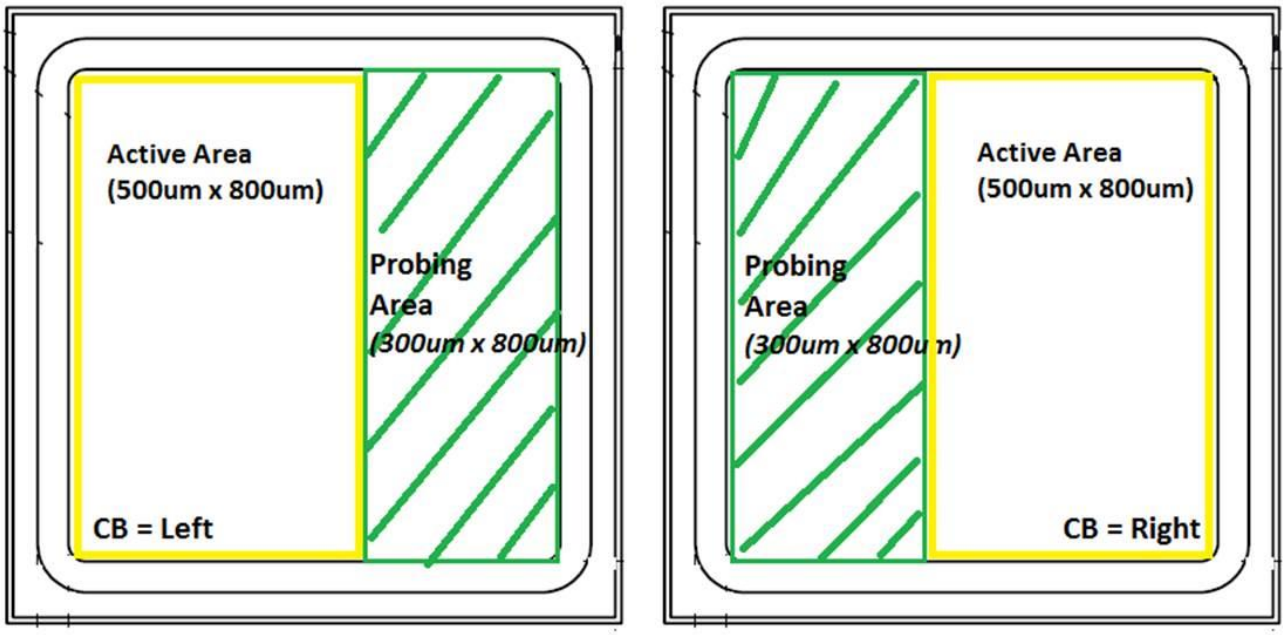
OHA04563

Dry Packing Process and Materials [9)]



OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



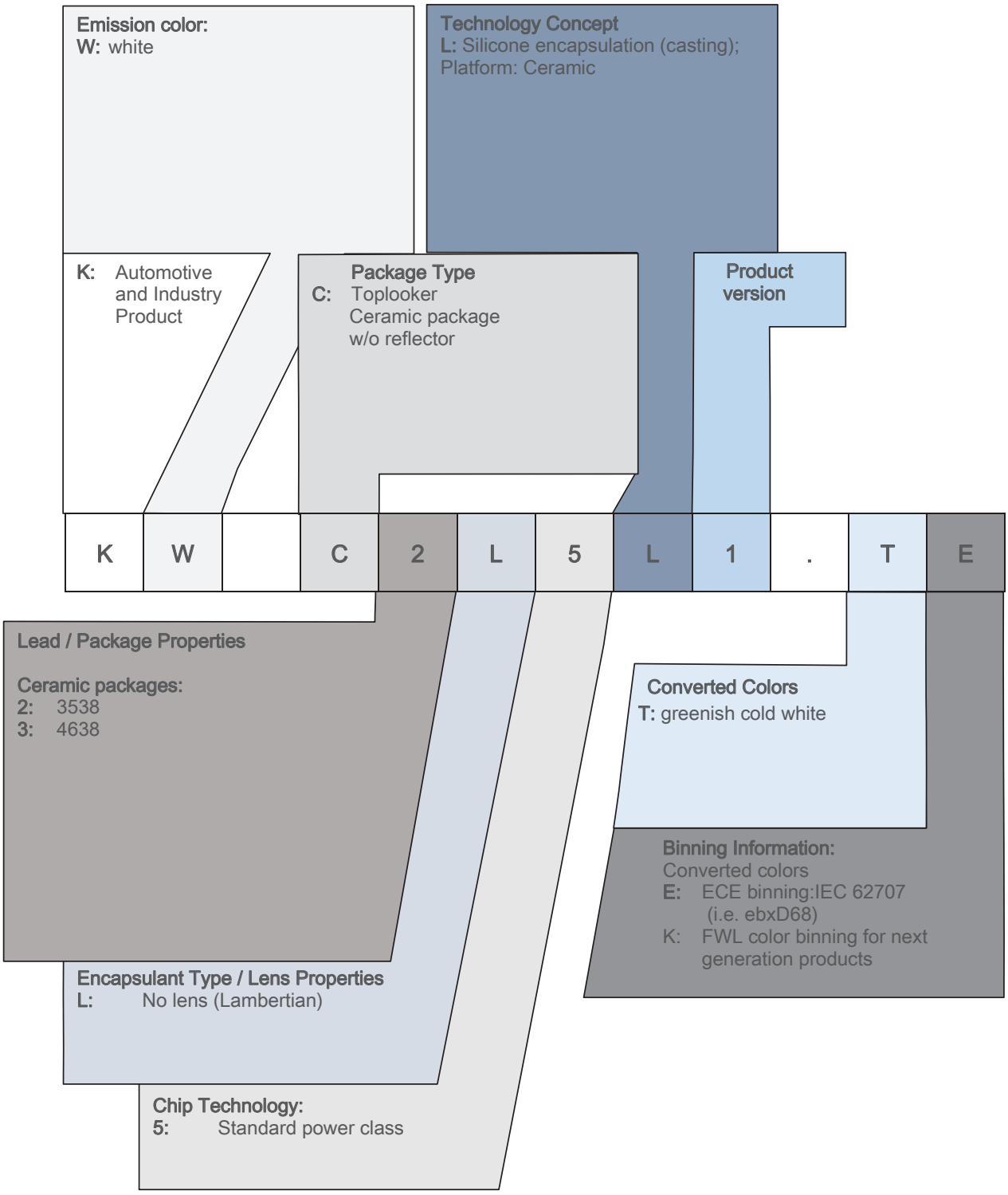
wire bonding scheme:

CB = contact block

Active Area = bond area

Probing Area = used by OSRAM OS

Type Designation System



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class **moderate risk (exposure time 0.25 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers avoid device exposure to aggressive substances during storage, production, and use.

For further application related information please visit https://ams-osram.com/support/application-notes

Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics.
Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.
For information on the types in question please contact our Sales Organization.
If printed or downloaded, please find the latest version on our website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.
Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.

Glossary

1) **Brightness:** Brightness values are measured during a current pulse of typically 1 ms, with an internal reproducibility of ±8 % and an expanded uncertainty of ±11 % (acc. to GUM with a coverage factor of k = 3).

2) **Operating Temperature:** The Operating Temperatur Top is referenced to the Solderpoint Ts of this device. Proper current derating must be observed to maintain junction temperature below the maximum.

3) **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.

4) **Chromaticity coordinate groups:** Chromaticity coordinates are measured during a current pulse of typically 1 ms, with an internal reproducibility of ±0.005 and an expanded uncertainty of ±0.01 (acc. to GUM with a coverage factor of k = 3).

5) **Forward Voltage:** The forward voltage is measured during a current pulse of typically 1 ms, with an internal reproducibility of ±0.05 V and an expanded uncertainty of ±0.1 V (acc. to GUM with a coverage factor of k = 3).

6) **Thermal Resistance:** Rth max is based on statistic values (6σ) used for Derating.

7) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

8) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.

9) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.

10) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision History

Version	Date	Change
1.0	2021-01-27	Initial Version
1.1	2021-06-18	Description
1.2	2021-09-01	Characteristics Electro - Optical Characteristics (Diagrams)
1.3	2024-02-08	New Layout Applications

EU RoHS and China RoHS compliant product
此产品符合欧盟 RoHS 指令的要求；
按照中国的相关法规和标准，
不含有毒有害物质或元素。

Published by ams-OSRAM AG
Tobelbader Strasse 30, 8141 Premstaetten, Austria
Phone +43 3136 500-0
ams-osram.com